# **DTC124X** series

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

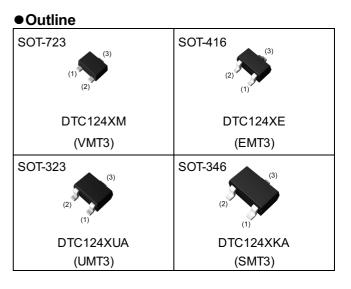
Parameter	Value	
V <sub>CC</sub>	50V	
I <sub>C(MAX.)</sub>	100mA	
R <sub>1</sub>	22kΩ	
R <sub>2</sub>	47kΩ	

## Features

1) Built-In Biasing Resistors,

 $R_1 = 22k\Omega, R_2 = 47k\Omega$ 

- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA124X series

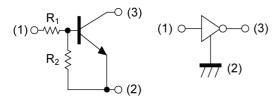


## Application

INVERTER, INTERFACE, DRIVER

# Inner circuit

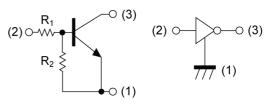
DTC124XM



(1) IN (BASE)(2) GND (EMITTER)(3) OUT (COLLECTOR)

## Packaging specifications

## DTC124XE/ DTC124XUA/ DTC124XKA



(1) GND (EMITTER)(2) IN (BASE)(3) OUT (COLLECTOR)

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC124XM	SOT-723 (VMT3)	1212	T2L	180	8	8000	45
DTC124XE	SOT-416 (EMT3)	1616	TL	180	8	3000	45
DTC124XUA	SOT-323 (UMT3)	2021	T106	180	8	3000	45
DTC124XKA	SOT-346 (SMT3)	2928	T146	180	8	3000	45

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## **DTC124X** series

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter			Values	Unit
Supply voltage			50	V
Input voltage		V <sub>IN</sub>	-10 to 40	V
Output current			50	mA
Collector current			100	mA
	DTC124XM		150	
Device dia sis stiss	DTC124XE	D *2	150	
Power dissipation	DTC124XUA		200	— mW
DTC124XKA			200	
Junction temperature	Tj	150	°C	
Range of storage tempera	T <sub>stg</sub>	-55 to +150	°C	

# •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Inputivaltage	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA		-	0.4		
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 2mA	2.5	-	- V		
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA	-	100	300	mV	
Input current	I <sub>I</sub>	V <sub>I</sub> = 5V	-	-	360	μA	
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA	
DC current gain	Gı	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	68	-	-	-	
Input resistance	R <sub>1</sub>	-	15.4	22	28.6	kΩ	
Resistance ratio	$R_2/R_1$	-	1.7	2.1	2.6	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz	

\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.



# •Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)



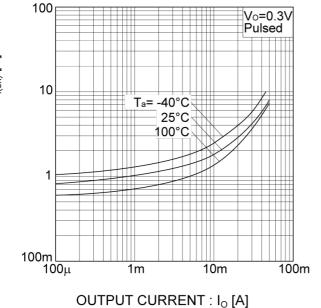


Fig.2 Output current vs. input voltage (OFF characteristics)

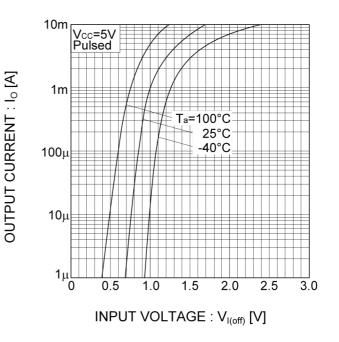


Fig.3 Output current vs. output voltage

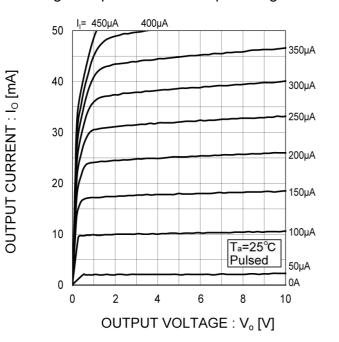
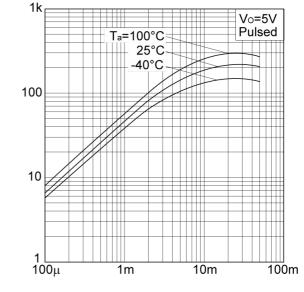


Fig.4 DC current gain vs. output current

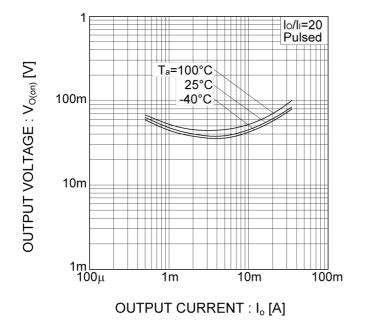


OUTPUT CURRENT :  $I_{o}$  [A]

DC CURRENT GAIN : G

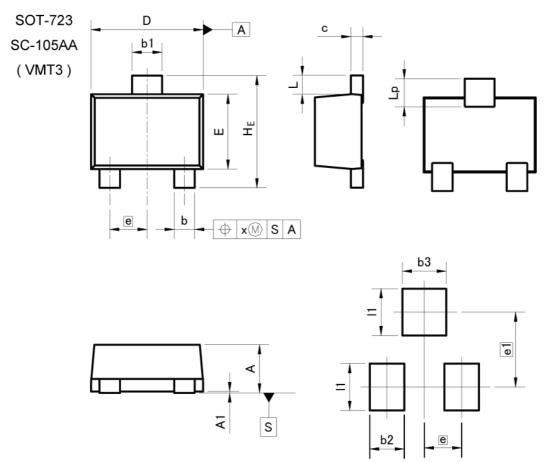


# •Electrical characteristic curves (T<sub>a</sub> =25°C)



## Fig.5 Output voltage vs. output current





Pattern of terminal position areas [Not a pattern of soldering pads]

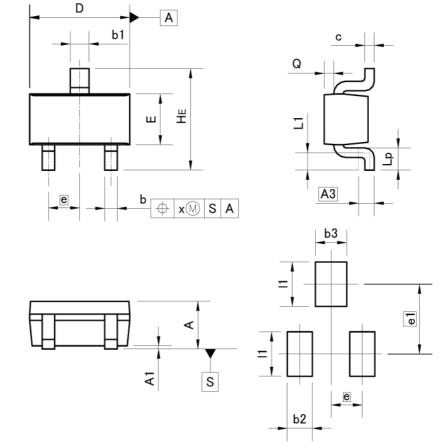
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.40		0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	Ξ.	0.10	-	0.004
	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	<b>2</b> 2	0.37	-	0.015
b3	<u>1995</u>	0.47	-	0.019
e1	0.	80	0.0	31
11	<del></del>	0.50	3.00	0.020

Dimension in mm/inches





(EMT3)



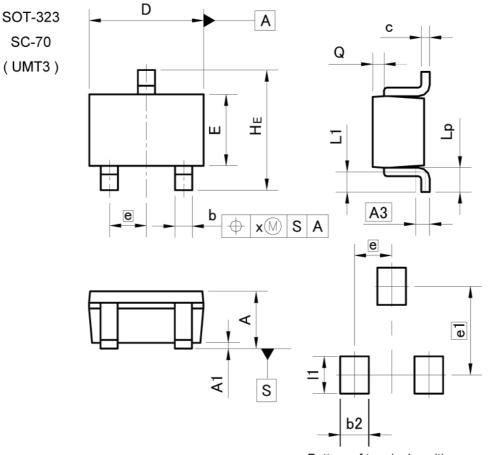
Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	2 <del></del>
Lp	0.15		0.006	3. <del>13</del>
Q	0.05	0.25	0.002	0.010
x	0.77	0.10	100	0.004

	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	1. <del>111</del>	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	043
11	277	0.70	Size (	0.028

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

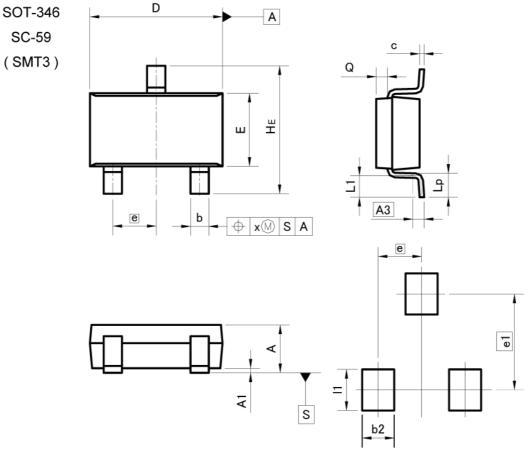
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	<del>en</del> é	0.10	2 <del></del>	0.004
	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
b2	<u>-</u>	0.50	· · · · · · · · · · · · · · · · · · ·	0.020
e1	1.55		0.0	61
11		0.65	1.77	0.026

Dimension in mm/inches



7/8

ROHM



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	)10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x	-1	0.10	11 <del>11</del>	0.004
У	=8	0.10		0.004
DIM	MILIMETERS		INC	HES
DTIN	MIN	MAX	MIN	MAX
b2	-2	0.60	-	0.024

Dimension in mm/inches

-

e1 11



0.90

2.10



0.035

0.083

-

# Notice

### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of	the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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